

PC Board Layout  
Component Side Shown

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD

NOTES:

ELECTRICAL:

- 1. VOLTAGE RATING : 125 VAC RMS MIN.
- 2. CURRENT RATING : 1.5 AMP MIN.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- 5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

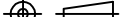
- 1. HOUSING MATERIAL : NYLON+30%.G.F(FR52)UL94V-0.
- 2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
- 3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.  
2: TAILS- PLATED TIN OVER NICKEL.
- 4. OPERATING LIFE : 750 CYCLES MIN.
- 5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
- 6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40°C TO +85°C.
  - 2. OPERATION : 0°C TO 70°C.
  - 3. WAVE SOLDER TEMPERTURE: 255°C TO 265°C 5~10 SECOND.
- MATES WITH MODULAR PLUG CONFORMING TO  
FCC PART 68, SUBPART F.  
CUL FILE NO. E163191

PART NUMBER: E576X-000XXX-L

- 2-2C 1-3u" 2-6u"
- 4-4C 3-15u" 4-30u"
- 6-6C 5-50u"
- A-FR52 3-W/ PANNEL STOP  
4-W/O PANNEL STOP

DETACHED LISTS	MM (INCH)		DFTO BASS	DATE 12/29/97	FULL RISE ELECTRONIC CO., LTD			
	TOLERANCES EXCEPT AS NOTED		CHKDQIANPU	DATE2005/3/22				
	MM	±	MFO	DATE	TITLE SIDE ENTRY PCB JACK 6P			
	.0 ±0.20	±	APPVISAMMY	DATE2005/3/22				
	.00 ±0.15	±	MATERIAL :		DRAWING NO. GE573003_LA			
	.000 ±0.075	±						
	ANGLES ±		QT'Y :		/PART NO. SEE NOTE		SIZE A3	REV 0
		FINISH :						
THIRD ANGLE PROJECTION		SCALE : 2.5:1		DO NOT SCALE DRAWING		SHEET X		OF Y